



Docket No.: 50432-234

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Minh Van NGO

Serial No.: 10/079,517

Filed: February 22, 2002

For: METHOD OF FORMING NITRIDE CAPPED CU LINES WITH IMPROVED
ADHESION AND REDUCED ELECTROMIGRATION ALONG THE
CU/NITRIDE INTERFACE

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Group Art Unit: 1742

Examiner: George P. Wyszomierski

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GROUP 1700

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REQUEST FOR RECONSIDERATION

Mail Stop
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Reconsideration of the rejections imposed in the Office Action dated May 6, 2003

is respectfully solicited in light of the following remarks.